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RESEARCH AND TECHNOLOGY DEPARTMENT

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The nickel composite plaque is a new concept application in alkaline energy storage systems.	
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atmosphere, produces a strong lightweight structu	
suitable for electrode use.	• • •
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Porosities of 55 to over 90 percent void volume are achievable with the composite plaques, while maintaining structural integrity. Porosimetry measurements indicate approximately a 4X greater than mean pore size and 1.5X broader pore size distribution than commercial powder sinter. Tensile strengths were measured as a function of nickel coating thicknesses. A strength of 75-85kg/cm was observed for plaques with fiber nickel coating thickness of about 1μ . Electrical resistivities of $400-600\mu\cdot\Omega\cdot\text{cm}$ were measured for plaques 1.0mm thick fabricated from fibers with 0.6-1.0 μ thick nickel coating.

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FOREWORD

This report explores some of the important physical parameters of the fiber composite nickel plaque under development at NSWC. Results from electrical resistivity, tensile strength, porosity by standard measurement techniques and plaque structure provided by scanning electron micrography have shown that lightweight, durable, and energy efficient electrodes can be fabricated.

Comparison with a high quality commercial nickel sintered plaque shows acceptable performance of the composite in every area. Moreover, a considerable range of overlap with parameter values common in powder sinters exists for the composite. This allows an excellent opportunity to optimize the latter for specific requirements. In addition to being lightweight, the composite plaques possess the desirable feature of a highly open, interconnected structure which is easily impregnated with active material.

The authors express their appreciation to Dr. M. K. Norr of the center for his fine work in providing the SEM photographs.

Accession For

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INTRODUCTION

A new concept in sintered plaque fabrication for use in electrode production for nickel alkaline battery systems is the nickel composite plaque. This plaque is made from highly graphitized carbon pitch mat fibers, coated with electroless nickel, compressed around a grid and sintered in a reducing ($\rm H_2$) atmosphere. The result is a strong lightweight sintered composite structure of open porosity suitable for use in various battery electrodes.

This report discusses the physical properties of this composite plaque material. These results have been derived from tests on only two sets of plaques and, therefore, must not be considered exhaustive. The reported data establishes an acceptable baseline for the composite plaque which can be compared to that of powder sintered plaques. The four test areas include tensile strength, porosity, resistivity and SEM micrography of the plaque structure.

EXPERIMENTAL PROCEDURE

Sintered nickel plaques have been the substrate of choice for many years as a medium for incorporation of electrochemically active material in secondary alkaline battery systems, where high rate capability and durability are important. Such plaques have been made conventionally by sintering a fine nickel powder.² They have the advantage of providing a highly conductive and porous substrate for containing the active species. Their disadvantages include weight and material/fabrication costs. The nickel composite plaque addresses these factors. The composite plaque is made by coating a graphite fiber mat (Thornel Type "P" VMA Grade, Union Carbide Corp.) using an electroless nickel solution (Allied-Kelite, Richardson Chemical Company). The nickel coated fiber is placed under compaction pressure around a current collection grid and sintered in a reducing (H₂) atmosphere.

All composite plaques used in this study were made from available graphite mat containing fibers approximately 7-17 μ in diameter (1 μ = 10⁻⁶ meter).

The electroless nickel coating, containing 2 to 10 percent phosphorous, has a eutectic point near 840°C. Sintering, therefore, must be carried out below this temperature to prevent the eutectic liquid from forming and running off the fibers during the process. A 2 hour sintering time is used, although based upon experience with powder sinters, 2 a period of 15 to 20 minutes is probably sufficient.

An initial set of plaques was sintered at 762°C and 812°C as a function of compaction pressure to assess the integrity of the fiber sinter bonds. A second set of plaques, containing the same amount of graphite fiber, was sintered as a function of nickel coating thickness to determine the effect of the nickel coating on the physical properties of the plaque. Typical data on the second plaque set is given in Table 1. This consisted of plaques produced with (nominal) nickel coating thicknesses of 0.3 to 1.5µ and plaque thicknesses of .75, 1.0, and 2.5mm, containing pure nickel expanded mesh current collectors. For comparison, a series of 1.0mm thick plaques, made without the current collector grid, is included. Finally, a 0.70mm thick commercial sinter was measured for reference.

POROSITY

Porosity measurements were made by water imbibition. Figure 1 shows the dependence of porosity on nickel coating thickness for the 0.75 and 1.0mm plaques at constant fiber content of 2.1 and 2.6 grams respectively. A variation of about 15 percent is observed in porosity as a function of nickel coating thickness.

Porosities of 55 percent to 95 percent have been produced in the composite plaques by varying the degree of compaction pressure (plaque thickness) for a given fiber content prior to sintering. Plaques fabricated with nickel coating less than 0.5μ thick tend toward structural weakness, blistering and fiber separation. These problems, however, are caused by inadequately coated portions of fiber resulting from non-uniformity due to hand processing. Composite plaques of good quality were obtained with nickel coating thicknesses in the range of 0.6 to 0.9μ .

PLAQUE PORE SPECTRUM BY MERCURY INTRUSION POROSIMETRY

The mercury intrusion porosimeter method produces data on the volume of mercury forced into a porous sample as a function of applied pressure. By computing the appropriate derivative $\Delta VHg/\Delta P$, the fractional porosity versus effective pore diameter is obtained. Figures 2(a) and 2(b) show the results of such measurements on a powder sinter and composite plaque, respectively.

TABLE 1. COMPOSITE PLAQUE PARAMETERS

Plaque Thickness mm(nom.)	Coating Thickness µ (nom.)	Porosity %	Resist- ivity μΩcm	Tensile Strength kg/cm ²		
0.75	0.3	88	673	36*	5.9	_
0.75	0.6	81	545	62*	7.8	-
0.75	0.9	75	434	72*	10.9	_
0.75	1.5	73	348	69*	13.9	_
1.0	0.3	95	869	3.5	6.4	-
1.0	0.6	86	650	48*	8.1	_
1.0	0.9	79	517	50*	11.0	-
1.0	1.5	79	430	69*	13.7	_
1.0 w/o grid	0.3	94	4228	12	3.6	66.0

Average of two runs

Manufacturer spec Crack observed in sinter

Grid break

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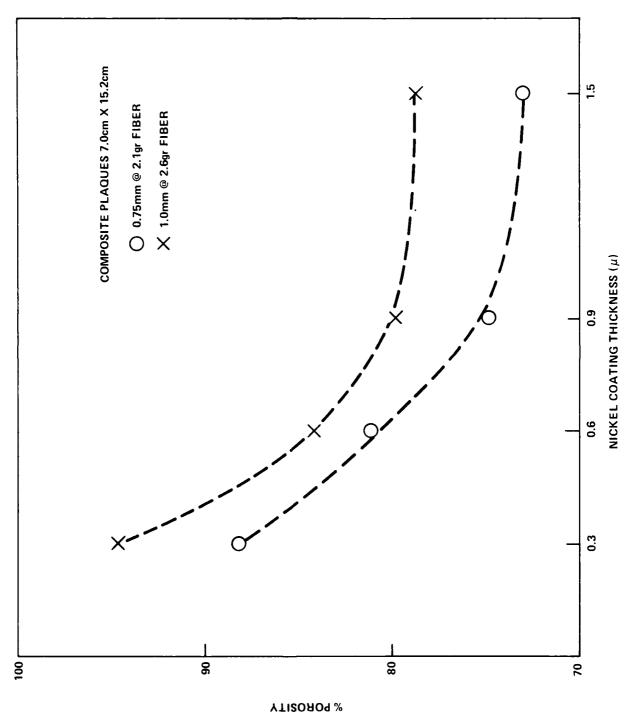
TABLE 1. (Cont.)

Plaque Thickness mm(nom.)	Coating Thickness µ (nom.)	Porosity %	Resist- ivity uncm	Tensile Strength kg/cm ²	Dry Weight grams	Mean Pore Diameter µ
1.0 w/o grid	0.6	83	1325	42	7.5	59.5
1.0 w/o grid	0.9	80	976	59	9.2	60.0
1.0 w/o grid	1.5	77	586	77	12.9	56.5
2.5	0.3	73	1578	19	13.7	~
2.5	0.6	80	1008	78	18.1	-
2.5	0.9	74	807	72	23.4	·-
0.70 powder	-	84*	140	44† 121⊽	14.1	15.0

Average of two runs Manufacturer spec

Crack observed in sinter

Grid break



NT FIBER CONTENT FIGURE 1. PLAQUE POROSITY VERSUS NICKEL COATING THICKNES AT U.

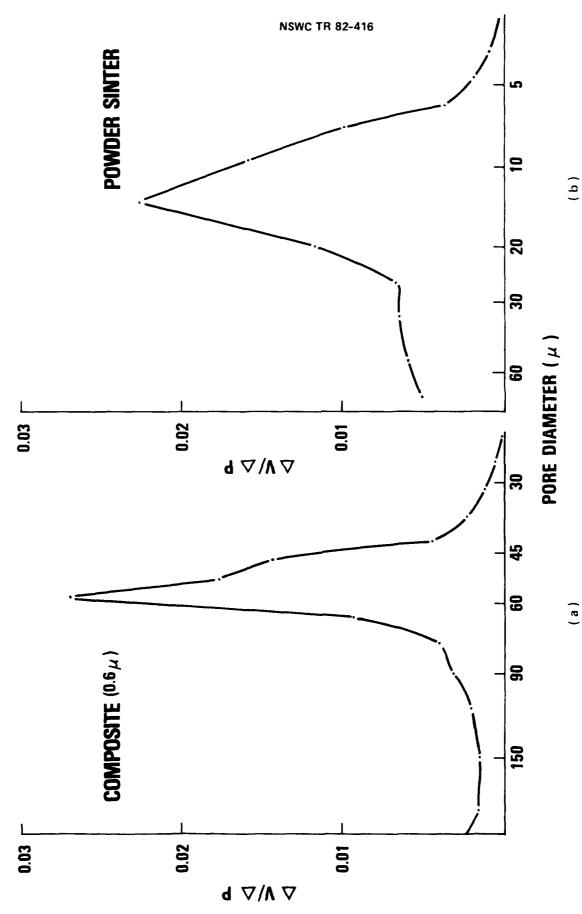


FIGURE 2. PLAQUE PORE SPECTRUM BY MERCURY INTRUSION POROSIMETRY

The number of pores of effective diameter indicated along the log axis is proportional to the curve height. The figures have a roughly similar shape with the maximum void volume occurring at about 15 μ for the powder sinter and 60 μ for the composite plaque. The porosity distribution is about 50 percent broader in the latter. As the nickel coating thickness is varied from 0.3 to 1.5 μ , the pore size distribution maximum shifts from 66 μ to 56 μ . These data quantify the pore size difference between the composite and typical powder plaque. For practical purposes the pores are considered spherical cavities. While this is far from the true topography of composite sinters, it is a convenient construct for cavity size comparisons.

The pore size versus nickel coating thickness dependence is not strong, as noted above. The 20 percent or so difference in pore size between plaques of thin and thick nickel coating is not likely to affect impregnation/formation conditions significantly. Of primary importance, however, is the 4X larger average pore size of the composite compared with powder sinters. The larger pores of the former may produce an electrode with some characteristics of the pocket plate. This implies some reduction in efficiency at high rate discharge com, ared with that of a powder sinter of equal thickness. Preliminary tests indicate that the composite plaque suffers a 5-10 percent penalty in active material utilization level compared with that typical of powder sinters. At this stage, the reduced utilization cannot be attributed reliably either to the larger pore size or marked differences in morphology between the composite and powder sinters. New, uniformly coated fibers of constant smaller diameter are becoming available. These will produce plaques of smaller, more uniform pore size, which will more closely match the pore size and surface area of the powder sinters.

SCANNING ELECTRON MICROSCOPIC STUDY

SINTER BOND STRENGTH

SEM photography is a powerful tool in examining sinter bonding, active material deposition, changes in morphology, etc. Figure 3 shows a portion of an impregnated plaque which has been cut and examined on edge. The stress of cutting has pulled apart two fibers at a sinter point, revealing the integrity of the sinter bond. This indicates the potential durability of the composite plaque under the physical and chemical stresses of cycling. The long-term plaque cycling test discussed below revealed that, although the nickel coating had considerably degraded, there was no evidence of disproportionate failure of the sinter bonds.

PLAQUE DURABILITY

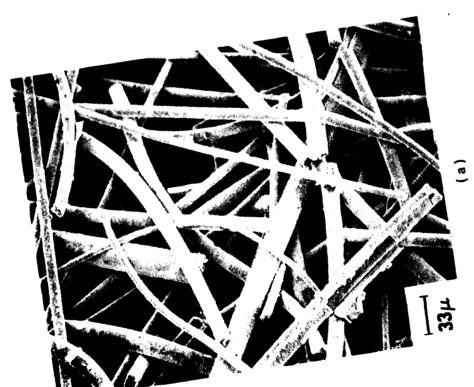
Two tests of plaque durability were made. In the first, a portion of composite plaque was immersed in 31 percent KOH electrolyte at 75°C for 2 months with no applied potential. Figures 4(a) and 4(b) show this sample before and



FIGURE 3. SEM PHOTOGRAPH OF FRACTURED SINTER BOND







after immersion. No major corrosive attack is evident. Therefore, plaque deterioration does not occur under open circuit conditons in the electrolyte. This result implies a potentially long "shelf" life of the composite electrode.

The second test involved long term alternating anodization (charge) and cathodization (discharge) periods at moderate current density, equivalent to 1000 cycles. Figure 5 shows the plaque after this test. It remains intact although the surface has assumed an eroded appearance. Oxidation of the nickel coating produced the equivalent of about 7 percent the utilization of a fully impregnated electrode of similar dimensions. Some exposed and split fibers are evident, probably due to gradual electrolyte penetration. These oxidation and penetration processes will set the limit on composite plaque lifetime.

PLAQUE MORPHOLOGY

An estimate of pore size can be obtained from SEM photographs by measurement and comparison. Figures 6(a) and 6(b) show portions of composite plaque at 200X and powder sinter plaque at 1000X respectively. The contrast in morphology and pore size is evident. The composite is composed largely of wedge-shaped cavities arranged in an interconnected open structure. Sintering takes place at contact points of the randomly directed mat fibers. The powder sinter has generally smaller pore cavities. Sintering takes place along entire particle chains which aggregate to form cavities. A far greater number of sinter bonds are involved in forming the powder sinter plaque.

These SEM photographs do not give information on closed porosity. No systematic study in this area was attempted. Such an investigation will require several cross section photographs of an impregnated plaque to determine the presence of unimpregnated regions.

The mat fiber material used in the composite plaques has a specific surface area of $0.4\text{m}^2/\text{gram}$, compared with an area of 0.25 to 0.5 m $^2/\text{gram}$ for nickel powders after sintering. Therefore, due to a 2 to 2.5X greater mass/volume, powder sintered plaques have this factor advantage in pore surface area. Smaller surface area for a given porosity in the composite plaque implies larger average pore size.

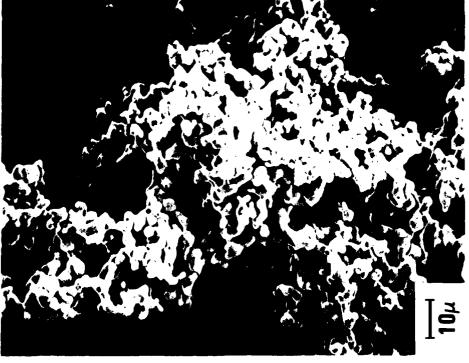
Figures 7(a) and 7(b) show portions of the composite plaque after impregnation and after charge-discharge cycling, respectively. In Figure 7(a), the nickel composite electrode (Ni.C.E.) has been formed but not cycled. The active material (nickel hydroxide) is present as isolated lumps loosely bound within the pore cavities. After heavy cycling (>200) in a test cell, the active material has redistributed to conform to the cavity walls (Figure 7(b)). It has assumed a smooth, layered appearance with visible electrolyte flow channels. The active material apparently has optimized its electrical contact with the plaque. This is reflected in a marked increase (30 to 40 percent) in utilization between the initial and final states pictured in Figure 7. The sensitivity of electrode performance to plaque and active material morphology is aptly illustrated. Not only must the plaque have a large accessible pore surface area, but also the active material must be distributed to contact it intimately.

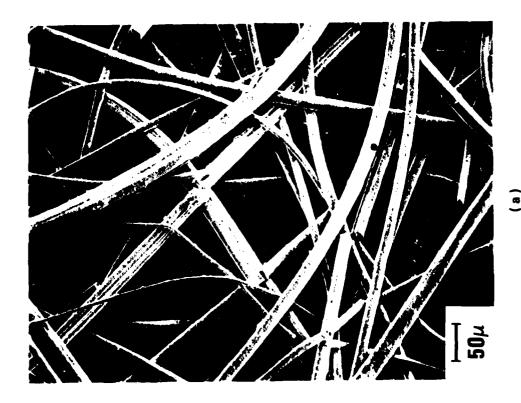
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FIGURE 5. CORROSION RESISTANCE OF COMPOSITE PLAQUE IN ELECTROLYTE

200X, FIBER SINTERED

1000X, POWDER SINTERED





(q)

FIGURE 6. MORPHOLOGY, PORE SIZE COMPARISON COMPOSITE VERSUS POWDER SINTER

500X UNCYCLED

500X CYCLED



FIGURE 7. IMPREGNATED COMPOSITE PLAQUE DISTRIBUTION OF ACTIVE MATERIAL

ELECTRICAL RESISTIVITY

For maximum utilization of the active material and electrical efficiency of a cell to be achieved, the electrode resistivity should be a minimum. Of concern in sintered plate battery systems is the plaque resistivity, which is an important contributor to the cell's internal resistance.

Electrical resistivities of the composite test plaques were measured using a four point probe method. A known current is passed through the plaque. A potential probe of fixed width is used to measure the voltage drop across a plaque segment. Using the thickness and other information, the local resistivity is computed. Such measurements were made on the series of composite plaques sintered at 762°C and 812°C . Figure 8 shows the electrical resistivity versus compaction pressure for this series. The cross-hatched region indicates the resistivity range common in nickel powder sinters. The best results were obtained at 812°C , 0.63μ nickel coating.

Using this result as a baseline, a second set of plaques (Table 1) was fabricated and measured. Figure 9 displays the results of these measurements. Average plaque resistivity is plotted as a function of nickel coating thickness. Figure 9 shows that thin plaques have significantly lower resistivity than thick ones. For the same nickel coating thickness, a composite plaque 2.5mm thick has about twice the resistivity of one 0.75mm .hick. The resistivity at each plaque thickness shows little decrease for coating thicknesses greater than about 0.6μ . The relatively lower resistivity of the thin plaques can be accounted for by the increased volume fraction occupied by the current collector (a pure nickel 0.15mm thick expanded metal grid) in the thin plates. A series of 1.0mm thick plaques was produced without the current collector grid in order to assess its contribution. The results are plotted as the upper curve of Figure 9. In the absence of the current collector, for a given nickel coating thickness, 1.0mm thick plaque has about twice the resistivity.

For comparison, the isolated point at lower right in Figure 9 indicates the measured resistivity of a recently manufactured 0.70mm thick powder sintered plaque. Its resistivity of $140\mu^{\circ}\Omega^{\circ}$ cm is about one-third that of a typical 0.75 to 1.0mm composite plaque of this series. Intersection with the practical resistivity range (~200 to $750\mu^{\circ}\Omega^{\circ}$ cm) determines the combinations of nickel coating and plaque thicknesses required for acceptable sinters. The data show that plaques thicker than 1.0mm will probably require heavier current collection grids to bring their resistivities within this range. If relatively thick nickel coatings are used, it might be possible to eliminate the current collector grid for some electrode applications.

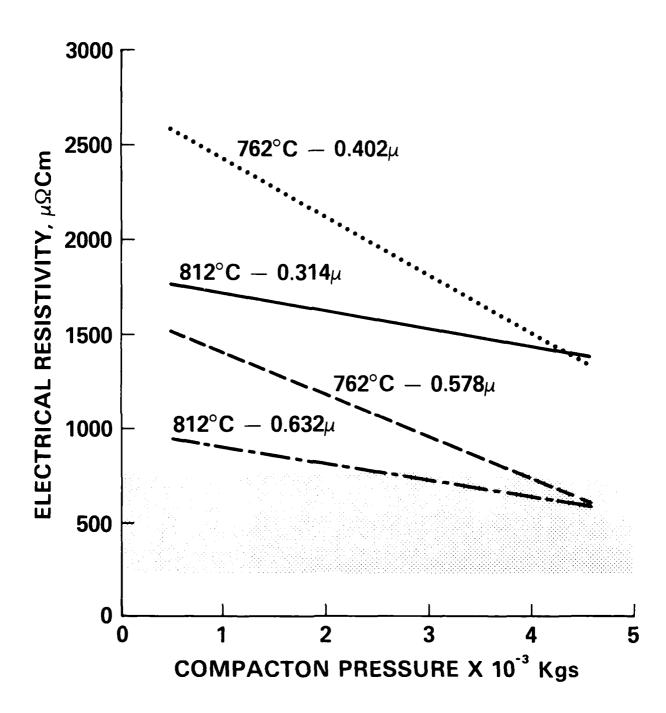
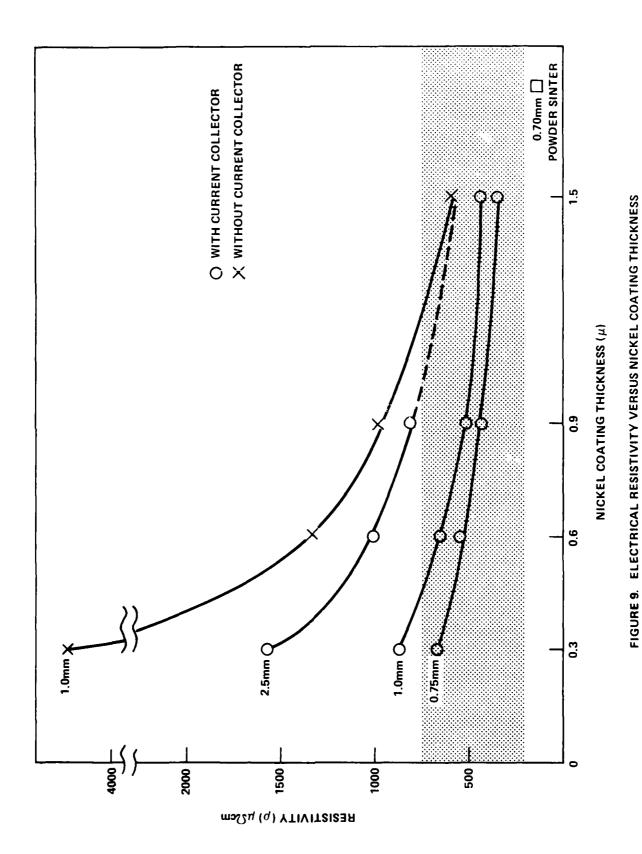


FIGURE 8. ELECTRICAL RESISTIVITY VERSUS COMPACTION PRESSURE



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TENSILE STRENGTH

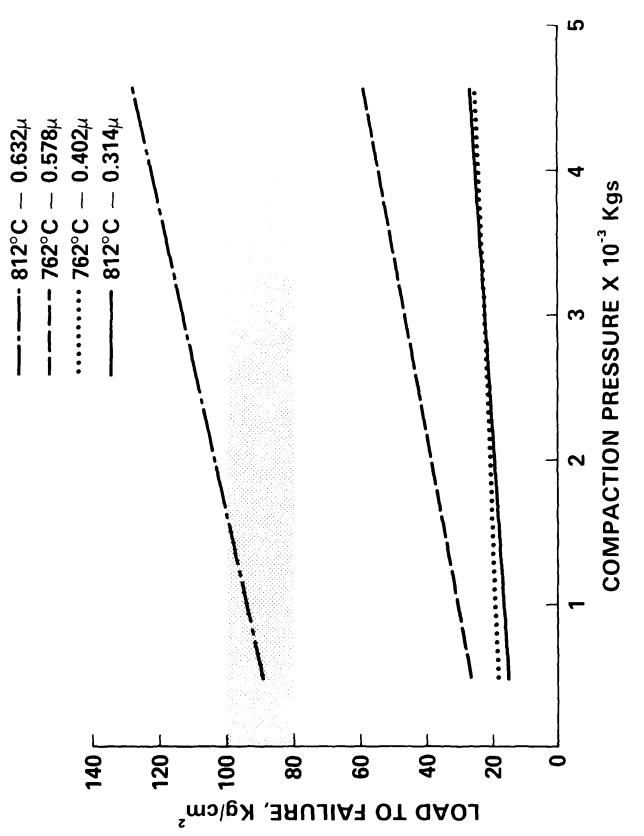
A simple test was used to determine the ultimate tensile strength of the composite plaques. The results were compared with those for powder sinters. The experimental arrangement used a hanging pedestal and weights to place the sample under static tension. The plaques were cut into strips of measured width. The only difficulty encountered was in devising a satisfactory holding method. Clamping the strip ends caused fiber damage and premature failure. The problem was solved by carefully epoxying small pieces of aluminum at each end of the strips. The test sample could then be placed conveniently under tension.

The load to failure (breakage) was recorded for each composite plaque sample of the first series. Figure 10 shows the failure load as a function of compaction pressure during sinter for various nickel coating thickness/ temperature combinations. The cross-hatch area indicates the range of tensile strengths obtained in powder sinters under normal processing conditions. The composite sinters processed at $800\,^{\circ}\text{C}$ with 0.6μ nickel coating produced the best results.

A second set of composite sinters was tested. Failure strength as a function of nickel coating thickness is shown in Figure 11. Vertical bars indicate two measurements on the same plaque. The data show increasing strength up to a nickel coating thickness of about 0.9μ . Above this coating thickness, the ultimate tensile appears to become constant at $75~\text{kg/cm}^2$. By constrast, from the data of Figure 10, increasing fiber content with compaction pressure translates into linear increase in tensile strength over the measured range. These data also show that tensile strengths greater than 75kg/cm^2 are possible in the composite plaques by increasing their fiber content. However, a penalty will be paid in decreased porosity. The 0.70mm thick, recently manufactured, powder sinter plaque exhibited a crack in the sinter at about 45kg/cm^2 as indicated in Figure 11. The ultimate tensile strength of 110kg/cm^2 was due principally to its current collector grid strength rather than to the sinter body.

CONCLUSIONS

Porosity of the composite plaque may be varied over a wide range of 55 to >90 percent by altering its fiber content. The mean pore size of plaques subjected to testing was about 4X and width of distribution about 1.5X those of powder sinter plaques. The achievement of smaller pore size while maintaining high porosity in the composite plaques necessitates that a graphite material of somewhat smaller, more uniform fiber diameter be used.



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FIGURE 10. TENSILE STRENGTH VERSUS COMPACTION PRESSURE

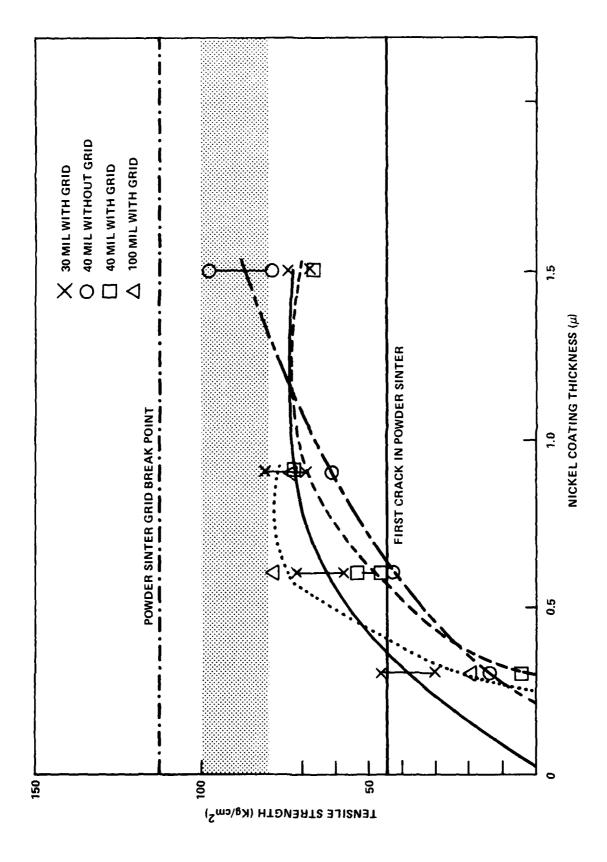


FIGURE 11. TENSILE STRENGTH VERSUS NICKEL COATING THICKNESS

SEM micrography confirms a composite plaque morphology of virtually 100 percent open interconnected porosity which readily accepts high active material impregnation levels. Micrographic observation of a cycled composite electrode indicates good intra-electrode electrolyte circulation.

The composite plaque electrical resistivity can be made comparable, by suitable nickel coating thickness, sinter temperature and fiber content, to that of typical powder sinters.

The ultimate tensile strength of the composite plaques increases with increasing nickel coating thickness, saturating at 75 to 85kg/cm^2 for nickel coating thicknesses around 0.9 μ . The tensile load is carried by the composite fiber structure rather than by the nickel conductor grid.

Good durability was noted for the composite plaque against corrosion under long term immersion in hot KOH electrolyte. Stability against dissolution was demonstrated by the unimpregnated composite plaque under anodization (charge) with gas evolution and cathodization (discharge) conditions equivalent to 1000 cycles.

A sintering temperature of 800°C and nickel coating thickness of 0.6 to $0.9\,\mu$ produce a composite plaque of suitable physical characteristics for cell use.

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